

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

5 Applicants: Min-Hsun Hsieh, Examiner: Wilson, Allan R  
Tzu-Feng Tseng,  
Wen-Huang Liu,  
Ting-Wei Yeh,  
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10 Filing Date: 07/14/2003 Art Unit: 2815  
Serial No.: 10/604,352 Docket No.: KYCP0009USA  
Confirmation No.: 1351 Customer No.: 27765

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15 Title: Light Emitting Diode Having an Adhesive Layer and a Manufacturing  
Method Thereof

To: Commissioner for Patents  
P.O. BOX 1450  
Alexandria, VA 22313-1450

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Subject: Response to the Office action mailed 06/23/2004

**INTRODUCTORY COMMENTS**

25 In response to the above-identified Office action, reconsideration of the  
above-identified application with regards to the remarks below is respectfully  
requested. The application is amended in an effort to overcome the rejections made  
by the examiner.